



## LOW-JITTER SAW OSCILLATOR (SPSO)

OUTPUT : LV-PECL, LVDS, HCSL

Product Number  
X1M0001x1xxxx00EG-4121CA  
EG-4101CA

- Frequency range : 100 MHz to 700 MHz
- Supply voltage : 2.5 V ... EG-4121CA  
3.3 V ... EG-4101CA
- Output : LV-PECL or LVDS or HCSL
- Function : Output enable (OE)
- External dimensions : 7.0 × 5.0 × 1.2 mm

- Very low jitter and low phase noise by SAW unit.

## Specifications (characteristics)

## ► Differential LV-PECL Output

Item	Symbol	EG-4121CA P	EG-4101CA P	Conditions / Remarks
		LV-PECL		
Output frequency range	f <sub>o</sub>	100 MHz to 700 MHz		Please contact us about available frequencies.
Supply voltage	V <sub>CC</sub>	2.5 V ± 0.125 V	3.3 V ± 0.33 V	
Storage temperature	T <sub>stg</sub>	-55 C to +125 C		Storage as single product.
Operating temperature	T <sub>use</sub>	W: -40 C to +85 C		
Frequency tolerance	f <sub>tol</sub>	G: ± 50 × 10 <sup>-6</sup>		
Current consumption	I <sub>CC</sub>	60 mA Max.		OE=V <sub>CC</sub> , L_ECL = 50 Ω
Disable current	I <sub>dis</sub>	2 mA Max.		OE=GND
Symmetry	SYM	45 % to 55 %		at outputs crossing point
Output voltage	V <sub>OH</sub>	1.55 V Typ.	2.35 V Typ.	DC characteristics
		V <sub>CC</sub> -1.025 V to V <sub>CC</sub> -0.88 V		
		0.8 V Typ.	1.6 V Typ.	
	V <sub>OL</sub>	V <sub>CC</sub> -1.81 V to V <sub>CC</sub> -1.62 V		
Output load condition (ECL)	L <sub>ECL</sub>	50 Ω		Terminated to V <sub>CC</sub> -2.0 V
Input voltage	V <sub>IH</sub>	70 % V <sub>CC</sub> Min.		OE terminal
	V <sub>IL</sub>	30 % V <sub>CC</sub> Max.		
Rise time / Fall time	t <sub>r</sub> / t <sub>f</sub>	400 ps Max.		Between 20 % and 80 % of (V <sub>OH</sub> -V <sub>OL</sub> )
Start-up time	t <sub>str</sub>	10 ms Max.		Time at minimum supply voltage to be 0 s
Phase Jitter	t <sub>pj</sub>	0.23 ps Max.		100 MHz ≤ f <sub>o</sub> < 150 MHz
		0.22 ps Max.		150 MHz ≤ f <sub>o</sub> < 200 MHz
		0.21 ps Max.		200 MHz ≤ f <sub>o</sub> < 300 MHz
		0.18 ps Max.		300 MHz ≤ f <sub>o</sub> < 400 MHz
		0.16 ps Max.		400 MHz ≤ f <sub>o</sub> < 500 MHz
		0.14 ps Max.		500 MHz ≤ f <sub>o</sub> < 600 MHz
0.10 ps Max.		600 MHz ≤ f <sub>o</sub> ≤ 700 MHz	Offset frequency: 12 kHz to 20 MHz	

## ► LVDS Output

Item	Symbol	EG-4121CA L	EG-4101CA L	Conditions / Remarks
		LVDS		
Output frequency range	f <sub>o</sub>	100 MHz to 700 MHz		Please contact us about available frequencies.
Supply voltage	V <sub>CC</sub>	2.5 V ± 0.125 V	3.3 V ± 0.33 V	
Storage temperature	T <sub>stg</sub>	-55 C to +125 C		Storage as single product.
Operating temperature	T <sub>use</sub>	W: -40 C to +85 C		
Frequency tolerance	f <sub>tol</sub>	G: ± 50 × 10 <sup>-6</sup>		
Current consumption	I <sub>CC</sub>	30 mA Max.		OE=V <sub>CC</sub> , L_LVDS=100 Ω
Disable current	I <sub>dis</sub>	15 mA Max.		OE=GND
Symmetry	SYM	45 % to 55 %		at outputs crossing point
Output voltage	V <sub>OD</sub>	350 mV Typ. 247 mV to 454 mV		DC characteristics
		50 mV Max.		
		1.25 V Typ. 1.125 V to 1.375 V		
		150 mV Max.		
Output load condition (LVDS)	L <sub>LVDS</sub>	100 Ω		Connected between OUT to OUT
Input voltage	V <sub>IH</sub>	70 % V <sub>CC</sub> Min.		OE terminal
	V <sub>IL</sub>	30 % V <sub>CC</sub> Max.		
Rise time / Fall time	t <sub>r</sub> / t <sub>f</sub>	400 ps Max.		Between 20 % and 80 % of Differential Output Peak to Peak voltage.
Start-up time	t <sub>str</sub>	10 ms Max.		Time at minimum supply voltage to be 0 s
Phase Jitter	t <sub>pj</sub>	0.27 ps Max.		100 MHz ≤ f <sub>o</sub> < 150 MHz
		0.24 ps Max.		150 MHz ≤ f <sub>o</sub> < 200 MHz
		0.23 ps Max.		200 MHz ≤ f <sub>o</sub> < 300 MHz
		0.19 ps Max.		300 MHz ≤ f <sub>o</sub> < 400 MHz
		0.16 ps Max.		400 MHz ≤ f <sub>o</sub> < 500 MHz
		0.14 ps Max.		500 MHz ≤ f <sub>o</sub> < 600 MHz
0.10 ps Max.		600 MHz ≤ f <sub>o</sub> ≤ 700 MHz	Offset frequency: 12 kHz to 20 MHz	

► HCSL Output

Item	Symbol	EG-4121CA H	EG-4101CA H	Conditions / Remarks
		HCSL		
Output frequency range	fo	100 MHz to 200 MHz		Please contact us about available frequencies.
Supply voltage	Vcc	2.5 V ± 0.125 V	3.3 V ± 0.3 V	
Storage temperature	T stg	-55 °C to +125 °C		Storage as single product.
Operating temperature	T use	W: -40 °C to +85 °C		
Frequency tolerance	f tol	G: ± 50 × 10 <sup>-6</sup>		
Current consumption	Icc	35 mA Max.		OE=Vcc, L_HCSL=50 Ω
Disable current	I dis	15 mA Max.		OE=GND
Symmetry	SYM	45 % to 55 %		at outputs crossing point
Output Voltage	V <sub>OH</sub>	0.75 V Typ.		DC characteristics
	V <sub>OL</sub>	-0.3 V Typ.		
Output load condition (HCSL)	L_HCSL	50 Ω		Terminated to GND
Input voltage	V <sub>IH</sub>	70 % Vcc Min.		OE terminal
	V <sub>IL</sub>	30 % Vcc Max.		
Rise time / Fall time	tr / tf	500 ps Max.		Between 0.175 V and 0.525 V of output
Start-up time	t str	10 ms Max.		Time at minimum supply voltage to be 0 s
Phase Jitter	t <sub>pj</sub>	0.3 ps Max.		Offset frequency: 12 kHz to 20 MHz
		0.4 ps Max.		
		0.2 ps Max.		

Product Name EG-4121 CA 250.000000MHz P G W A

(Standard form)

① ② ③ ④⑤⑥⑦

① Model ② Package type ③ Frequency

④ Output (P: LV-PECL, L: LVDS, H: HCSL)

⑤ Frequency tolerance ⑥ Operating temperature

⑦ Frequency aging (A\*1: Frequency tolerance include aging)

\*1 This includes initial frequency tolerance, temperature variation, supply voltage change, reflow drift, and aging(+25 °C, 10 years).

⑤ Frequency tolerance	G	±50 × 10 <sup>-6</sup>
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⑥ Operating temp.	W	-40 °C to +85 °C
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Table 2 Jitter

Item	Symbol	Specifications	Remarks
Jitter *	t <sub>DJ</sub>	0.3 ps Typ.	Deterministic Jitter
	t <sub>RJ</sub>	2 ps Typ.	Random Jitter
	t <sub>RMS</sub>	2 ps Typ.	σ (RMS of total distribution)
	t <sub>P-P</sub>	20 ps Typ.	Peak to Peak
	t <sub>acc</sub>	3 ps Typ.	Accumulated Jitter(σ) n=2 to 50 000 cycles

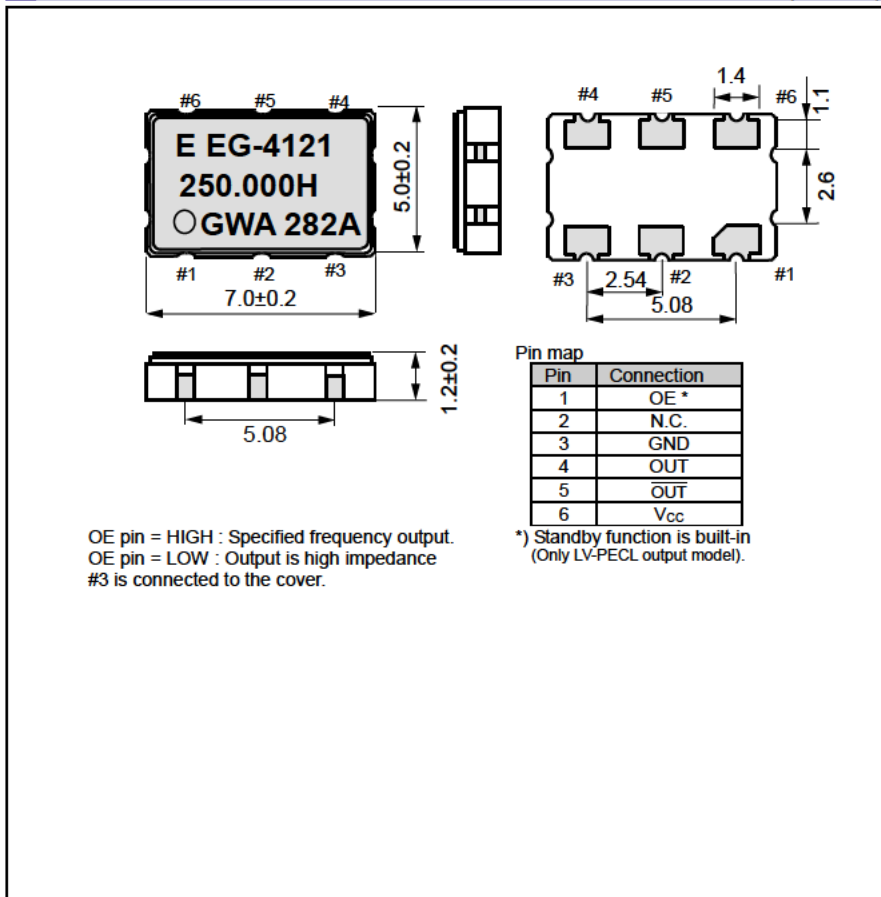
\* Tested using a DTS-2075 Digital timing system made by WAVECREST with jitter analysis software VISI6.

\* Based on SIA-3100C signal integrity analyzer made from WAVECREST.

: LV-PECL, LVDS output  
: HCSL output

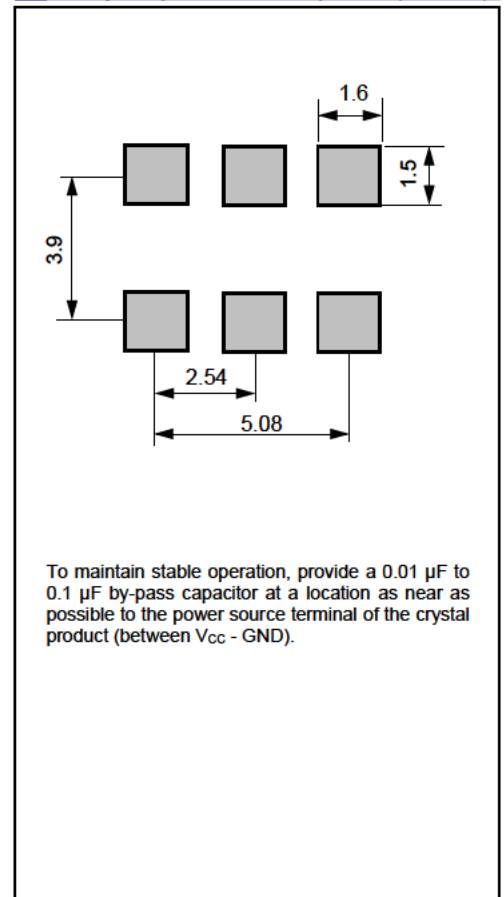
External dimensions

(Unit:mm)



Footprint (Recommended)

(Unit:mm)



## PROMOTION OF ENVIRONMENTAL MANAGEMENT SYSTEM CONFORMING TO INTERNATIONAL STANDARDS

At Seiko Epson, all environmental initiatives operate under the Plan-Do-Check-Action (PDCA) cycle designed to achieve continuous improvements. The environmental management system (EMS) operates under the ISO 14001 environmental management standard.

All of our major manufacturing and non-manufacturing sites, in Japan and overseas, completed the acquisition of ISO 14001 certification.

ISO 14000 is an international standard for environmental management that was established by the International Standards Organization in 1996 against the background of growing concern regarding global warming, destruction of the ozone layer, and global deforestation.

## WORKING FOR HIGH QUALITY

In order provide high quality and reliable products and services than meet customer needs, Seiko Epson made early efforts towards obtaining ISO9000 series certification and has acquired ISO9001 for all business establishments in Japan and abroad. We have also acquired IATF 16949 certification that is requested strongly by major automotive manufacturers as standard.

IATF 16949 is the international standard that added the sector-specific supplemental requirements for automotive industry based on ISO9001.

### ► Explanation of the mark that are using it for the catalog

	► Pb free.
	► Complies with EU RoHS directive. *About the products without the Pb-free mark. Contains Pb in products exempted by EU RoHS directive. (Contains Pb in sealing glass, high melting temperature type solder or other.)
	► Designed for automotive applications such as Car Multimedia, Body Electronics, Remote Keyless Entry etc.
	► Designed for automotive applications related to driving safety (Engine Control Unit, Air Bag, ESC etc ).

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